

Electronic Acknowledgement Receipt

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Application Number:	10801954
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Title of Invention:	Method and system for analyzing defects of an integrated circuit wafer
First Named Inventor:	Shu-Sing Liao
Customer Number:	22470
Filer:	Warren Scott Wolfeld
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Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1		RESPONSE_A.pdf	219565	yes	10

	Multipart Description		
	Doc Desc	Start	End
	Response to Election / Restriction Filed	1	1
	Claims	2	9
	Applicant Arguments/Remarks Made in an Amendment	10	10
Warnings:			
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